

Substitute for form 1449A/PTO

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet	1	of	1
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Complete if Known

Application Number	10/642,908
Filing Date	August 18, 2003
First Named Inventor	Tan et al.
Group Art Unit	Unknown
Examiner Name	Unknown
Attorney Docket Number	2269-5163.1US (01-0910.01/US)

U.S. PATENT DOCUMENTS

[illegible]

FOREIGN PATENT DOCUMENTS

[illegible]

**Examiner
Signature**

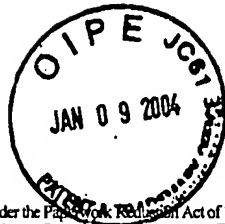
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¹ Applicant's unique citation designation number (optional). ² See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

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PTO/SB/08A (10-01)



PTO/SB/08B(10-01)

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Application Number	10/642,908
Filing Date	August 18, 2003
First Named Inventor	Tan et al.
Group Art Unit	3712
Examiner Name	Unknown
Attorney Docket Number	5163 IUS (01-0910.01/IIS)

Sheet 2 of 3

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS

Examiner Initials *	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
AR	—	U.S. Patent Application Publication 2002/0171177 A1 to Kritchman et al., dated November 21, 2002	
AR	—	U.S. Patent Application Publication 2003/0043360 A1 to Farnworth, dated March 6, 2003	
AR	—	U.S. Patent Application Publication 2003/0151167 A1 to Kritchman et al., dated August 14, 2003	
AR	—	U.S. Patent Application Publication 2003/0207213 A1 to Farnworth, dated November 6, 2003	
		MILLER et al., "Maskless Mesoscale Materials Deposition", Deposition Technology, September 2001, pages 20-22	
		MILLER, "New Laser Directed Deposition Technology", Microelectronic Fabrication, August 2001, page 16	
		Webpage, Objet Prototyping the Future, "Objet FullCurve 700 Series", 1 page	
		Webpage, Objet Prototyping the Future, "How it Works", 2 pages	
AR		U.S. Patent Application No. 10/191,424, filed July 8, 2002, entitled "Semiconductor Devices With Permanent Polymer Stencil and Method for Manufacturing the Same", inventor Farnworth et al.	
AR		U.S. Patent Application No. 10/201,208, filed July 22, 2002, entitled "Thick Solder Mask for Confining Encapsulant Material Over Selected Locations of a Substrate, Assemblies Including the Solder Mask, and Methods, inventor Grigg et al.	
AR		U.S. Patent Application No. 10/370,755, filed February 20, 2003, entitled "Chip Scale Package Structures and Method of Forming Conductive Bumps Thereon", inventor Warren M. Farnworth	

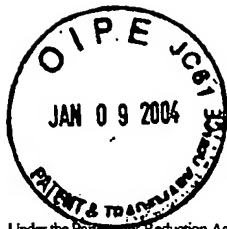
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AR	—	U.S. Patent Application No. 10/672,098, filed September 26, 2003, entitled "Apparatus and Methods for Use in Stereolithographic Processing of Components and Assemblies", inventor Warren M. Farnworth	—
AR	—	U.S. Patent Application No. 10/688,354, filed October 17, 2003, entitled "Thick Solder Mask for Confining Encapsulant Material Over Selected Locations of a Substrate and Assemblies Including the Solder Mask", inventor Grigg et al.	—

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